

Description

The TD3150L series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to an integrated circuit with a power output stage in a plastic DIP8 package with different lead forming options.

Features

- High isolation 5000 VRMS
- DC input with a high speed driver
- Operating temperature range 40 °C to 100 °C
- REACH compliance
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

Applications

- Isolated IGBT/Power MOSFET gate drive
- Industrial Inverter
- AC brushless and DC motor drives
- Induction Heating

SCHEMATIC 1 2 7 3 4

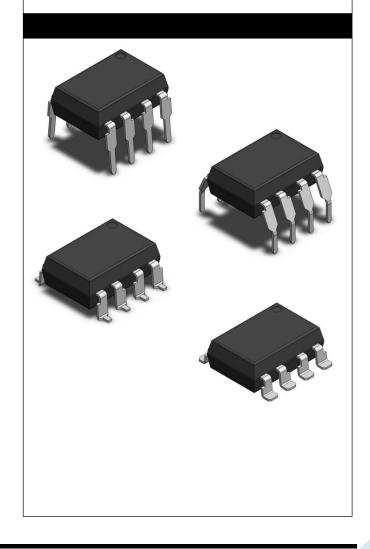
PIN DEFINITION

 1.NC
 8.VCC

 2.Anode
 7.VO

 3.Cathode
 6.VO

 4.NC
 5.GND





ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	Note			
INPUT							
Forward Current	IF	25	mA				
Peak Forward Current	IFP	50	mA	1			
Peak Transient Current	IF(trans)	1	Α	2			
Operating Frequency	f	50	kHz				
Reverse Voltage	VR	5	V				
Input Power Dissipation	PI	100	mW				
OUTPUT							
Supply Voltage	VCC	35	V				
Output Voltage	VO	35	V				
Peak Output Current	Ю	0.8	Α				
Output Power Dissipation	РО	250	mW				
COMMON							
Total Power Dissipation	Ptot	295	mW				
Isolation Voltage	Viso	5000	Vrms	3			
Distance Through Insulation	Dti	0.5	mm				
Operating Temperature	Topr	-40~100	°C				
Storage Temperature	Tstg	-55~150	°C				
Soldering Temperature	Tsol	260	°C	4			

Note 1. 50% duty, 1ms P.W

Note 2. ≤1µs P.W, 300pps

Note 3. AC For 1 Minute, R.H. = $40 \sim 60\%$

Note 4. For 10 seconds

TRUTH TABLE					
LED	VDD-VSS "Positive Going"	VDD-VSS "Negative Going"	VO		
LED	(Turn-on)	(Turn-off)	VO		
Off	0V to 30V	0V to 30V	Low		
On	0V to 11.5V	0V to 10V	Low		
On	11.5V to 13.5V	10V to 12V	Transition		
On	13.5V to 30V	12V to 30V	High		



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RECOMMENDED OPERATION CONDITIONS						
PARAMETER	SYMBOL	MIN.	MAX.	UNIT		
Operating Temperature	TA	-40	100	°C		
Supply Voltage	VCC	10	30	V		
Input Current (ON)	IF(ON)	7	16	mA		
Input Voltage (OFF)	VF(OFF)	0	0.8	V		

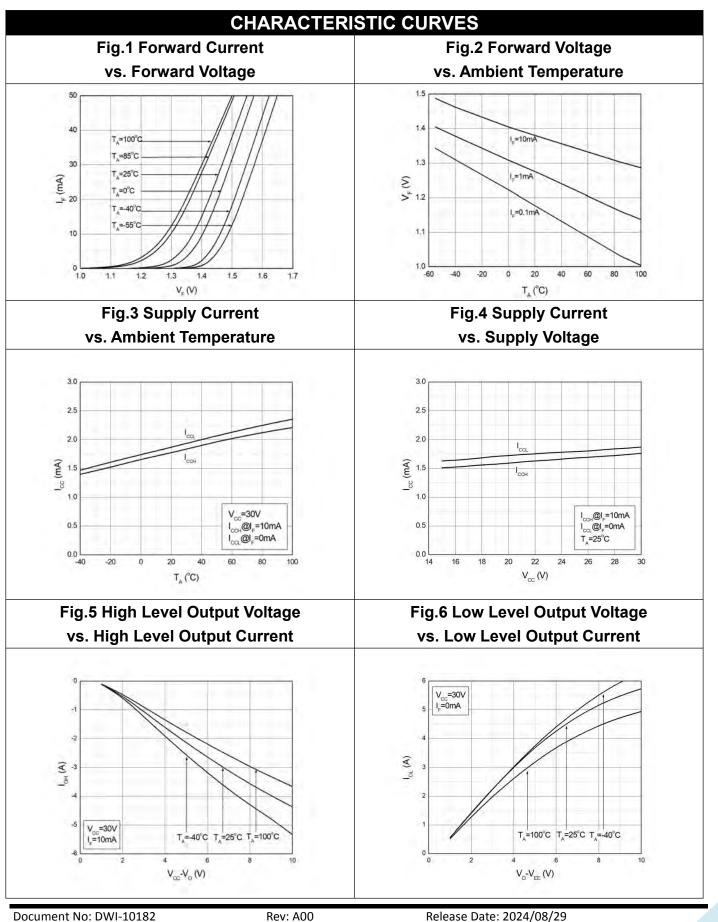
ELECTRICAL OPTICAL (CHARACTE	ERISTICS	(VCC=30V	, VEE=GN	ND, TA	A=25°C unless specified otherw	/ise)	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE	
INPUT CHARACTERISTICS								
Forward Voltage	VF	-	1.38	1.8	V	IF=10mA		
Reverse Current	IR	-	-	10	μΑ	VR=5V		
Input Capacitance	Cin	-	13	-	pF	V=0, f=1MHz		
		OUTPL	JT CHARA	CTERISTI	CS			
High Level Supply Current	ICCH	-	1.9	3	mA	IF= 7mA to 10mA, VO= Open		
Low Level Supply Current	ICCL	-	2.1	3	mA	VF = 0 to 0.8V, VO= Open		
	TRANSFER CHARACTERISTICS							
High Level Output Voltage	VOH	VCC-2.5	VCC-1.5	-	V	IF= 10mA, IO= -100mA		
Low Level Output Voltage	VOL	-	VEE+0.25	VEE+0.4	V	IF= 0mA, IO= 100mA		
High Land Orton to Organia	IODII	-0.3	-	-	Α	VO= VCC-3.0V		
High Level Output Current	IOPH	-0.8	-	-	Α	VO= VCC-6.0V		
Lavel aval Output Compant	IODI	0.3	-	-	Α	VO= VEE+1.5V		
Low Level Output Current	IOPL	0.8	-	-	Α	VO= VEE+2.5V		
Input Threshold Current	IFLH	-	2	5	mA	IO= 0mA, VO> 5V		
Input Threshold Voltage	VFHL	0.8	-	-	V	IO= 0mA, VO< 5V		
Under Voltage Lockout	VUVLO+	6.9	7.8	8.7	V	IO= 10mA, VO> 5V		
Threshold	VUVLO-	5.9	6.7	7.5	V	IO= 10mA, VO< 5V		
Isolation Resistance	Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capacitance	CIO	-	1.0	-	pF	V=0, f=1MHz		



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ELECTRICAL OPTICAL	CHARACTERIS	TICS (VCC=3	0V, VEE	=GND, T	A=25°C unless specified other	rwise)	
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE	
	SWITCHING CHARACTERISTICS							
Propagation Delay Time	TPHL	50	250	500	ns			
to Output Low Level	11 112	30	250	300	113			
Propagation Delay Time	TPLH	50	220	500	ns	IF= 7 to 16mA,		
to Output High Level	11 611	30	220	300	113	CL= 1nF, RL= 30Ω ,		
Pulse Width Distortion	TPHL-TPLH	-	30	200	ns	f= 10kHz, Duty = 50%,		
Propagation Delay Skew	tPSK	-200	-	200	ns	TA= 25 °C		
Rise Time	tr	-	30	-	ns			
Fall Time	tf	-	30	-	ns			
UVLO Turn On Delay	tUVLO(ON)	-	1.6	-	μs	IF= 10mA, VO> 5V		
UVLO Turn Off Delay	tUVLO(OFF)	-	0.4	-	μs	IF= 10mA, VO< 5V		
Common Mada Transiant						IF=7 to 16mA		
Common Mode Transient	СМН	-20	-	-	kV/µs	VCC= 30V, TA= 25 °C,		
Immunity at Logic High						VCM= 2kV		
Common Mode Transient						IF=0mA		
	CML	20	-	-	kV/µs	VCC= 30V, RL, TA= 25 °C,		
Immunity at Logic Low						VCM= 2kV		

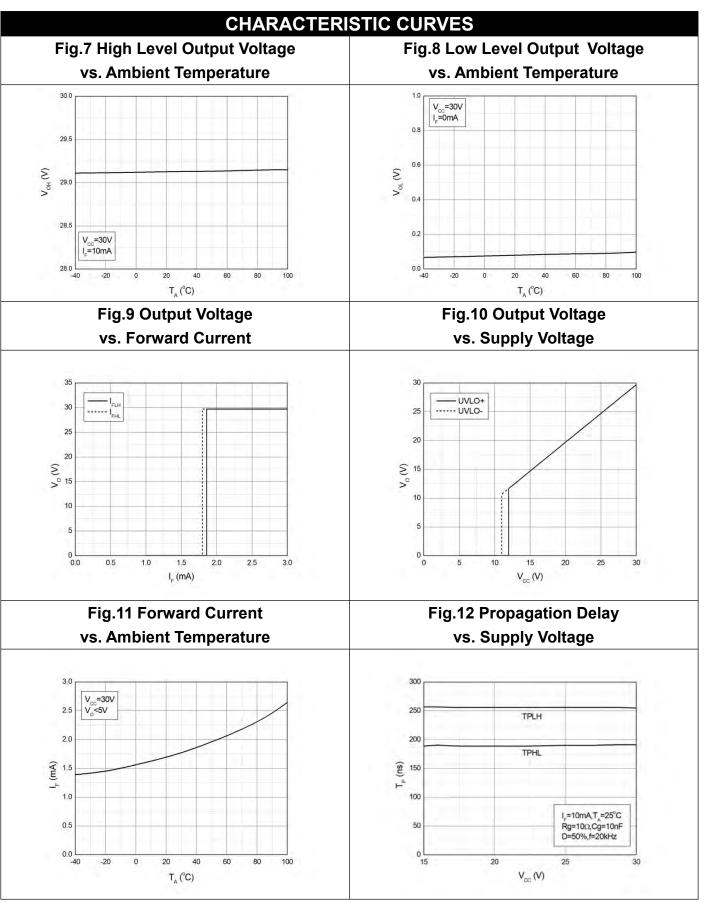






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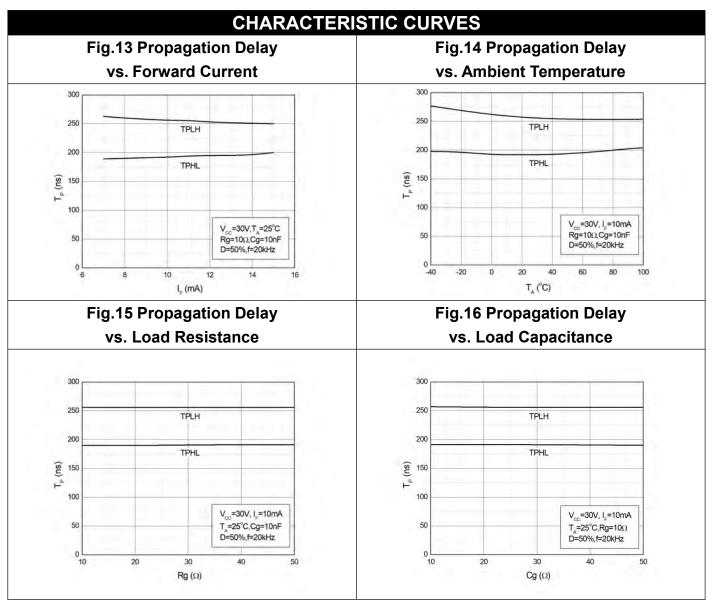
DIP8, DC Input, 0.8A, Gate Driver Photo Coupler



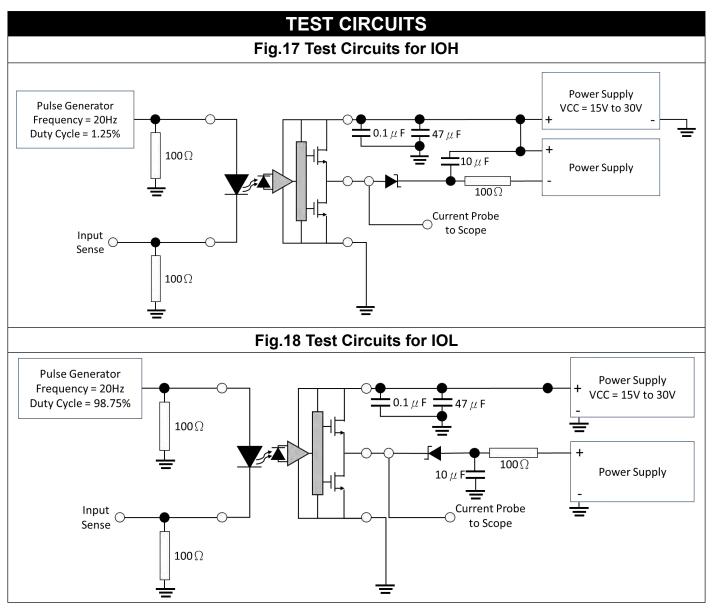
Rev: A00

Release Date: 2024/08/29

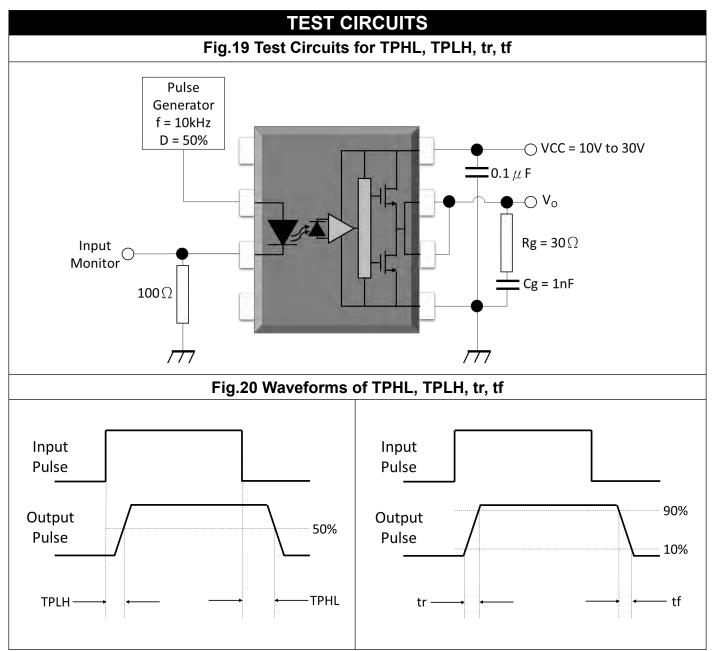




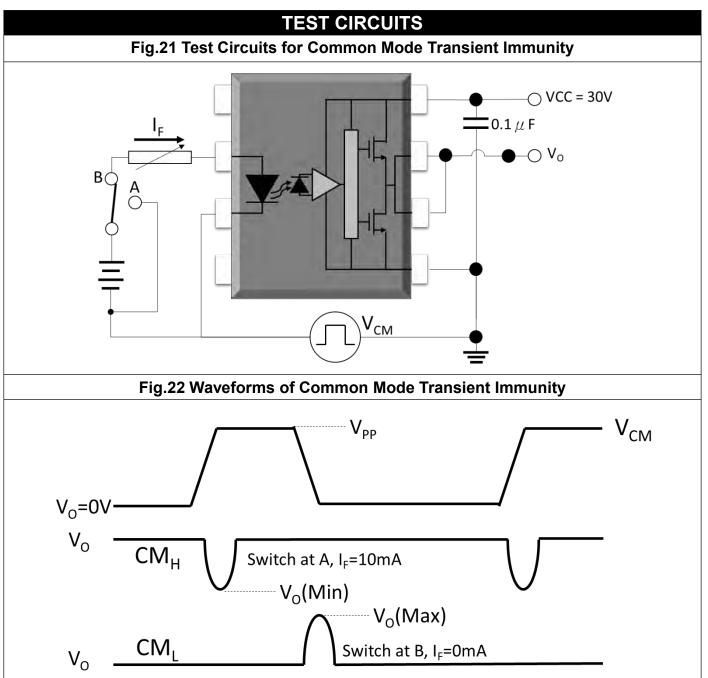




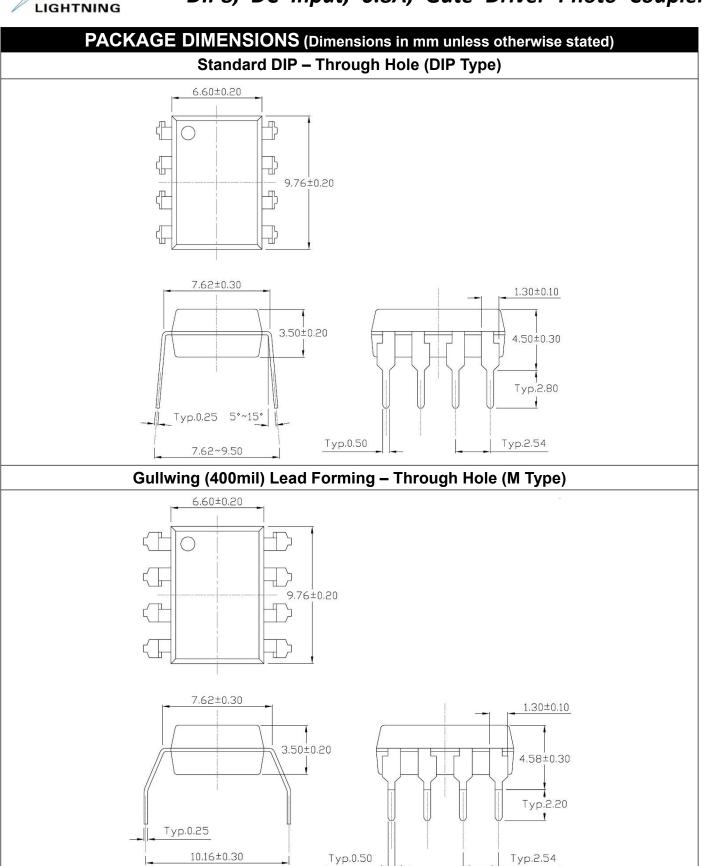




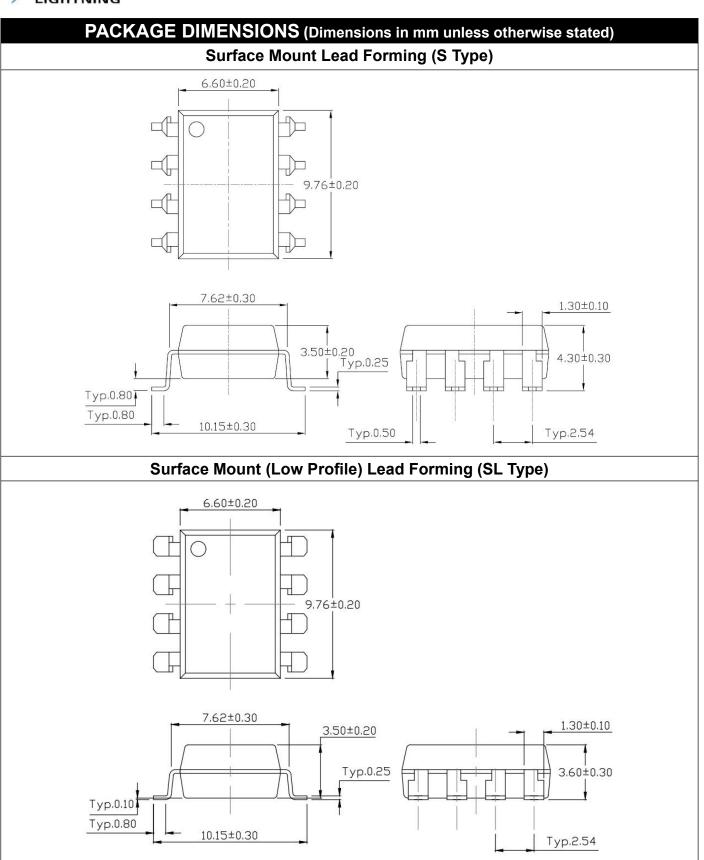






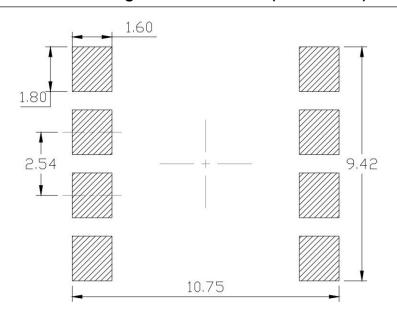




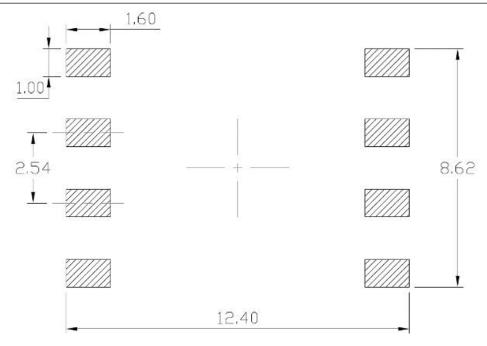




Recommended Solder Mask (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

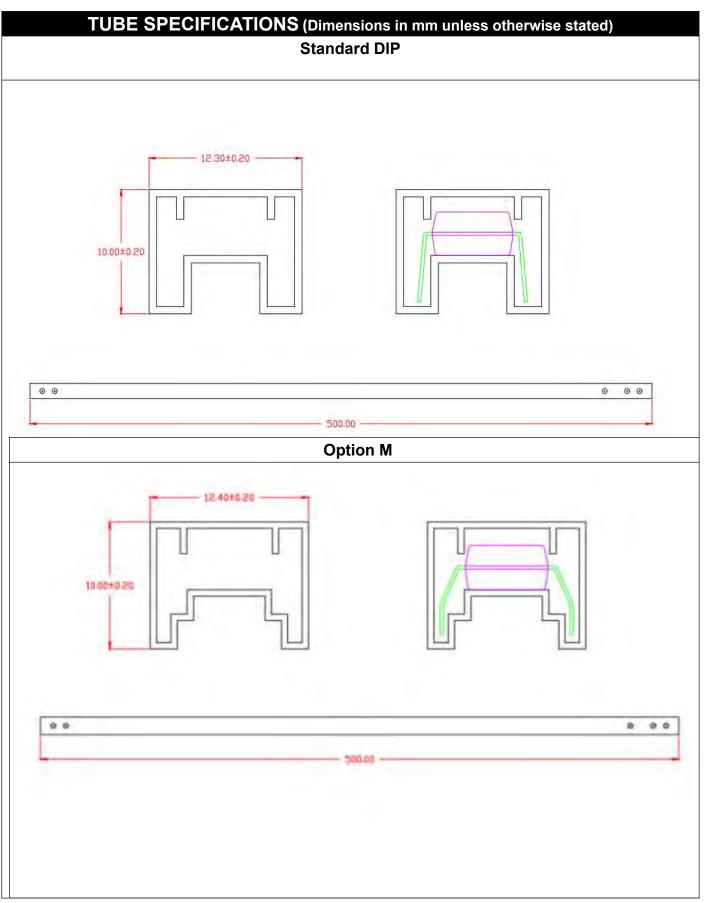


Surface Mount (Gullwing) Lead Forming

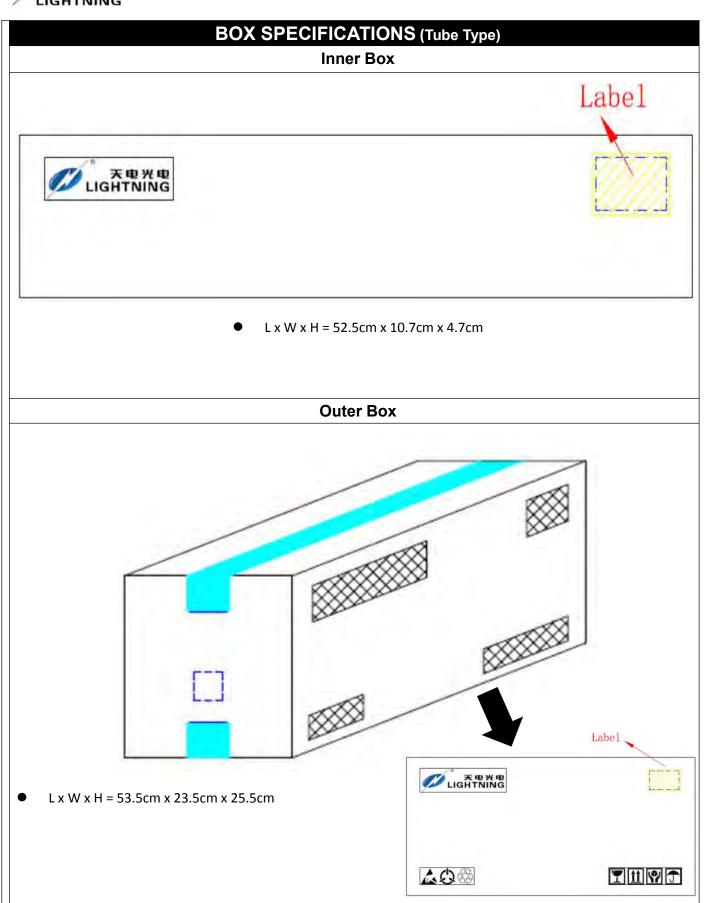




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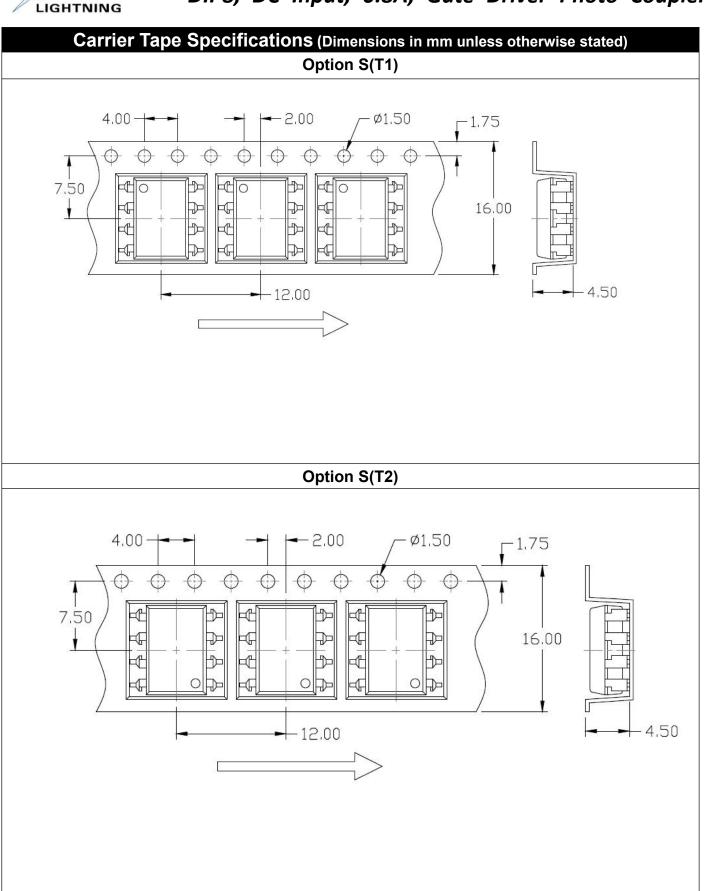




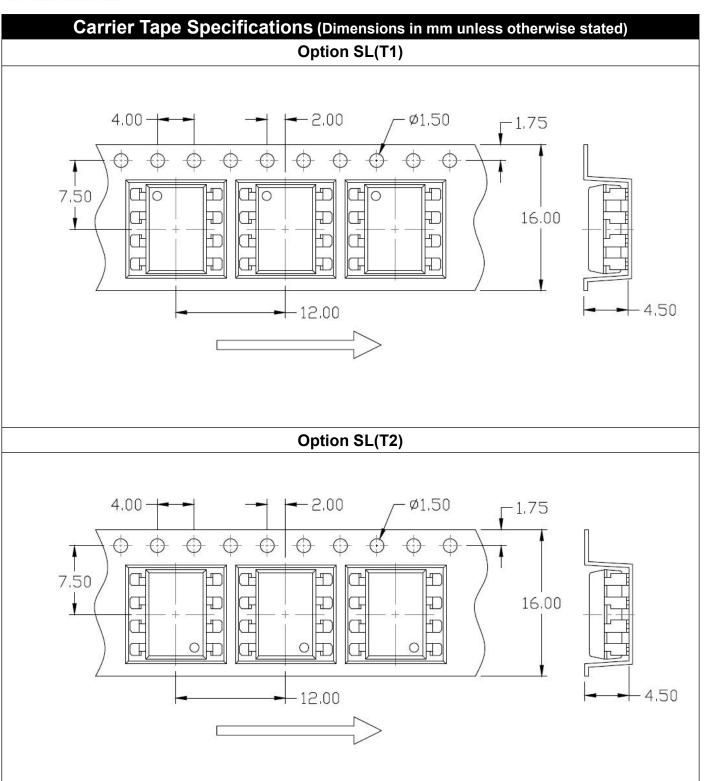


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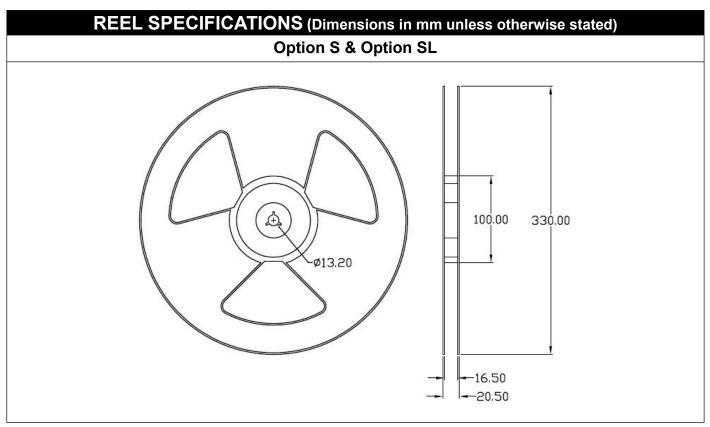


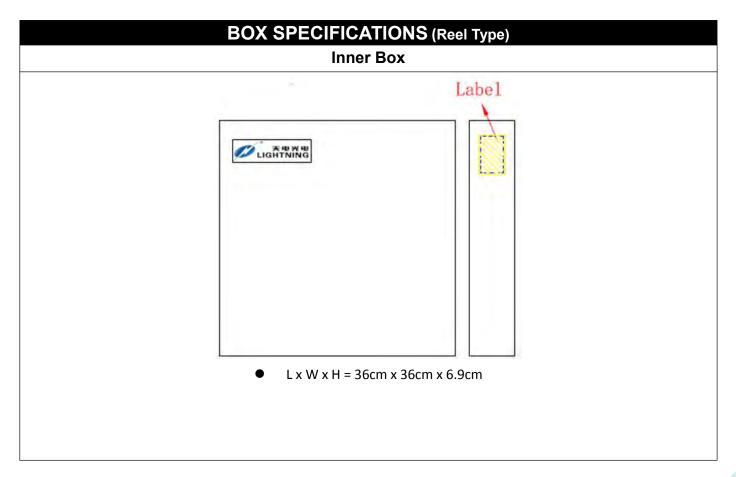




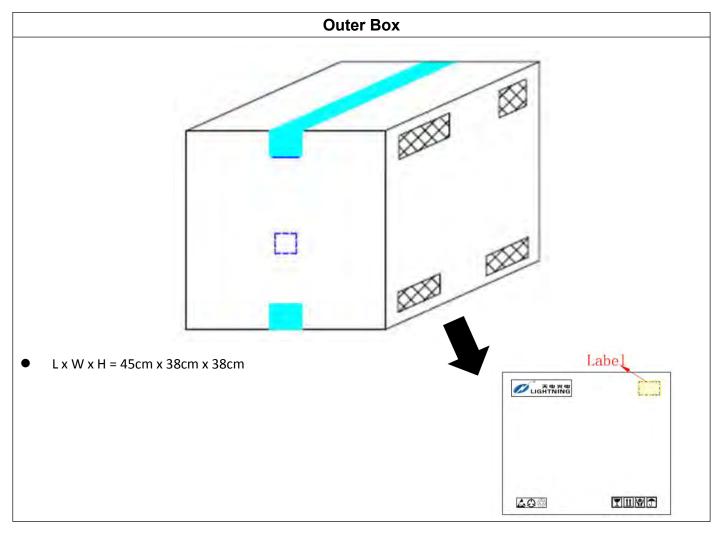








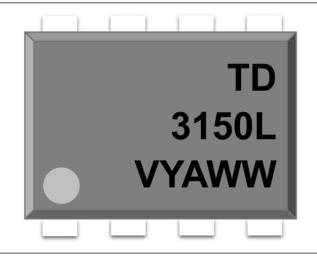






ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

3150L : Part Number

V : VDE Option Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

ORDERING INFORMATION

TD3150L(Y)(Z)-GV

TD – Company Abbr.

3150L - Part Number

Y - Lead Form Option

(M/S/SL/None)

Z – Tape and Reel Option (T1/T2)

G - Material Option

(G: Green, None: Non-Green)

V – VDE Option (V or None)

LABEL INFORMATION

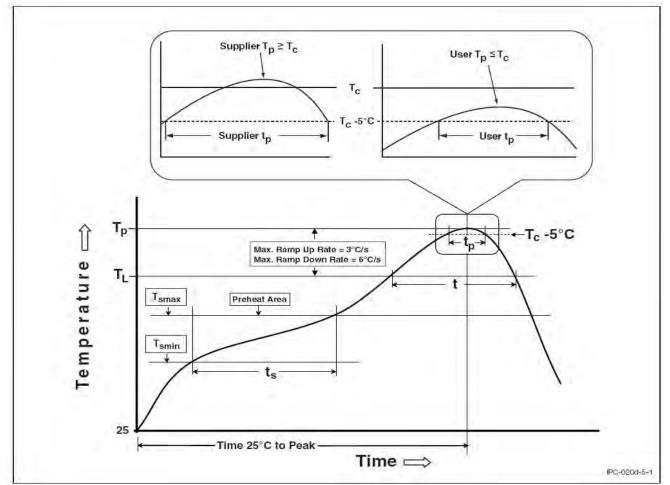


PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box			
None	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 14.4k Units			
М	45 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 14.4k Units			
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units			
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units			
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units			
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units			

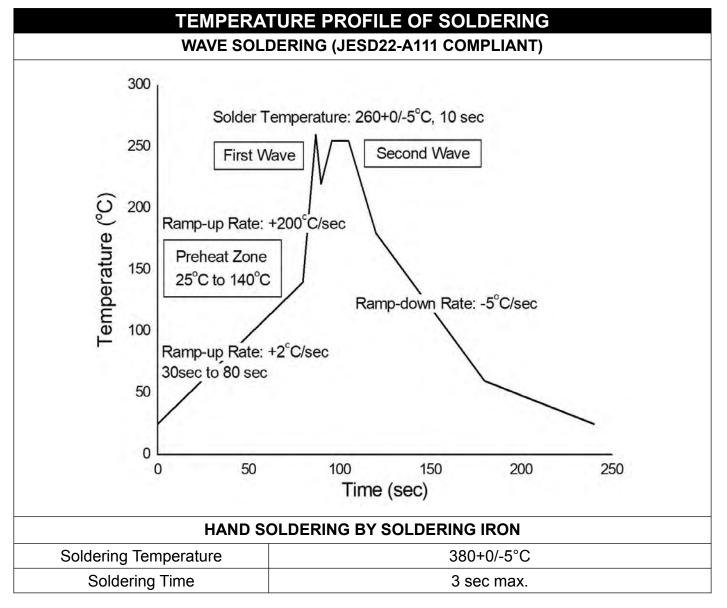


REFLOW INFORMATION REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



DISCLAIMER

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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
 over time. All operating parameters, including typical parameters, must be validated in each
 customer application by the customer's technical experts. Product specifications do not expand or
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- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.